20-bit input bitstream conversion DAC for digital audio systems

SAA7350

BITSTREAM CONVERSION

FEATURES

- Up to 20-bit input
- Variety of interface formats (Japanese and I²S)
- Choice of two system clock frequencies
- Sampling frequency from 16 kHz to 53 kHz
- Third order noise shaping to increase signal-to-noise ratio
- Bitstream conversion, using switched capacitor one-bit DAC
- Differential mode output configuration
- Single power supply operation (+5 V)
- −10 to +70 °C operating temperature range
- Output interface for TDA1547

GENERAL DESCRIPTION

The SAA7350 is a CMOS digital-to-analog converter using Philips bitstream conversion technique. The device is designed for mid/high performance digital audio systems (particularly compact disc). The device also can be used with the TDA1547 device for top performance digital audio systems.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	MIN.	TYP.	MAX.	UNIT
V_{DD}	supply voltage range	4.5	5.0	5.5	V
f_{XTAL}	crystal frequency (256 f_s)	-	11.2896	-	MHz
f_{XTAL}	crystal frequency (384 f_s)	-	16.9344	-	MHz
DR	dynamic range	93	98	-	dB
THD	total harmonic distortion	-	−96	−93	dB
	digital silence	-	−103	−100	dB

ORDERING INFORMATION

EXTENDED TYPE NUMBER	PACKAGE			
	PINS	PIN POSITION	MATERIAL	CODE
SAA7350GP	44	QPF	plastic	SOT205AG

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PINNING

SYMBOL	PIN	DESCRIPTION
XSEL	1	crystal frequency select; this pin is used to select the master crystal frequency as follows: XSEL HIGH = 384 f_s, XSEL LOW = 256 f_s; if unconnected the pin will default HIGH
$\overline{\text{DOEN}}$	2	one-bit digital output enable; when LOW, the one-bit code outputs are made available for TDA1547; if unconnected the pin will default HIGH
IDF3, IDF2, IDF1	3, 4, 5	input data format; these three pins determine the input format the device is to operate in (see functional description); if unconnected these pins will default HIGH (i.e. burst clock mode)
TEST4	6	test 4; this pin should be left open-circuit
SDI2	7	serial data input; used in simultaneous mode only (for the right channel signal); when not used, this pin will be internally pulled HIGH
SDI1	8	serial data input; this should be a 16, 18 or 20-bit linear 2's complement PCM signal; in simultaneous mode this pin is used for the left channel signal
WSI	9	serial input word select signal; signifies whether data word is for the left or right channel; can be either f_s, 2 f_s, 4 f_s or 8 f_s where f_s is the system sampling frequency; f_s can be between 16 kHz and 53 kHz
SCKI	10	bit clock input for the serial input interface
TEST1	11	test 1; this pin should be left open-circuit
V_{DDD}	12	+5 V power supply for the digital section
V_{SSD}	13	ground connection for the digital section
XIN	14	crystal oscillator input
XOUT	15	crystal oscillator output
XSYS1	16	buffered oscillator output
TEST5	17	test 5; in normal operation this pin should be tied LOW
V_{DDAR}	18	analog 5 V supply for right channel
INTR+	19	output from the right positive switched-capacitor integrator; input to differential operational amplifier
FBR+	20	feedback connection for the right positive switched-capacitor integrator
V_{SSAR}	21	0 V supply for right channel
FBR-	22	feedback connection for the right negative switched-capacitor integrator
INTR-	23	output from the right negative switched-capacitor integrator; input to differential operational amplifier
V_{RCR}	24	high impedance voltage reference for right channel inputs; typically $V_{DDAR}/2$
V_{DACR}	25	reference voltage supply for right channel DAC's; normally this will be connected to V_{SS}
V_{ROR}	26	right channel voltage reference output; typically $V_{DDAR}/2$
V_{DDATR}	27	5 V supply for right channel analog timing
V_{SSAT}	28	0 V supply for left and right channel analog timing
V_{DDATL}	29	5 V supply for left channel analog timing
IRR	30	24 kΩ bias resistor connection for the reference current generator circuit

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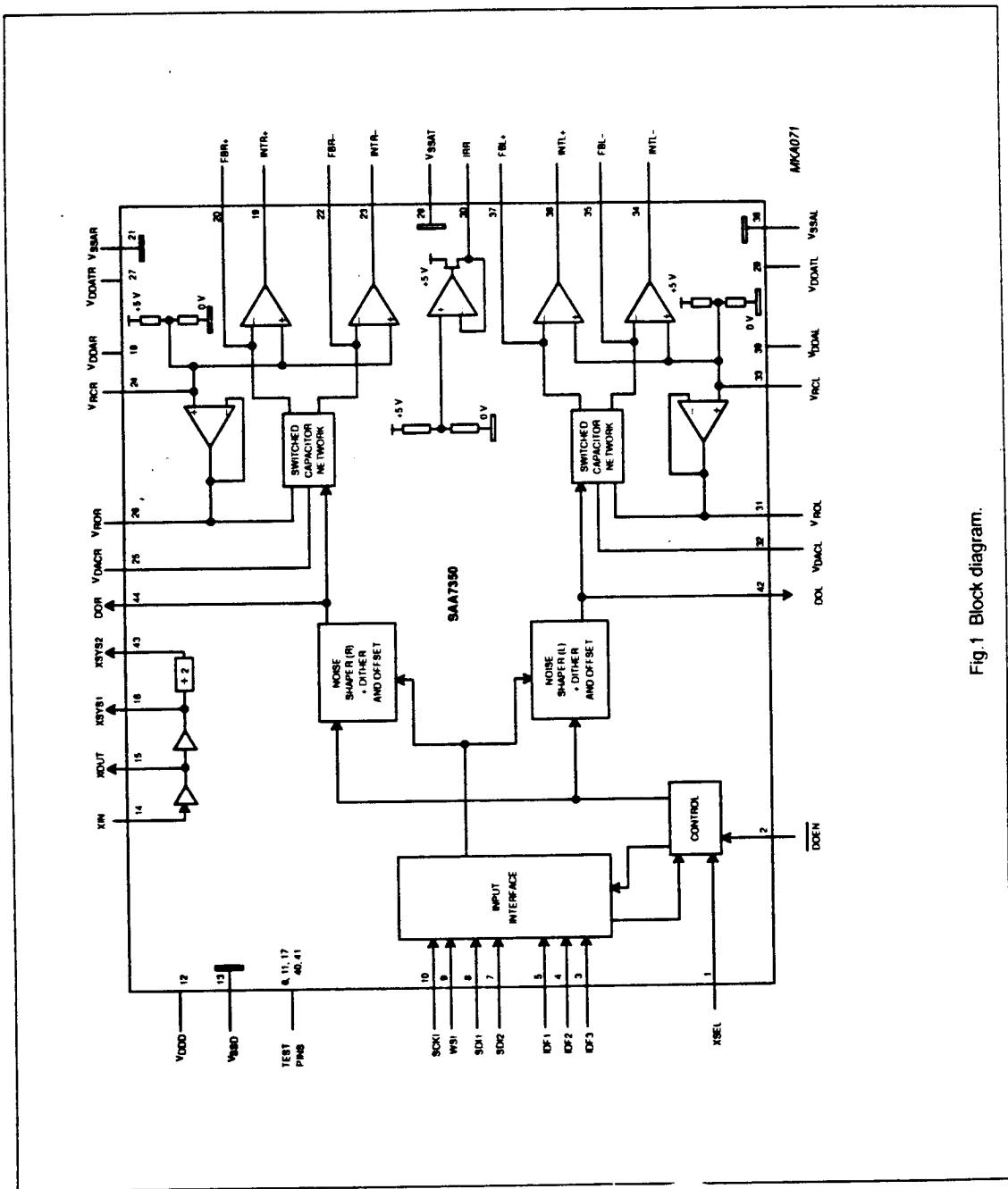
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Fig.1 Block diagram.

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PINNING

SYMBOL	PIN	DESCRIPTION
V_{ROL}	31	left channel voltage reference output; typically $V_{DDAL}/2$
V_{DACL}	32	reference voltage supply for left channel DAC; normally this will be connected to V_{ss}
V_{RCL}	33	high impedance voltage reference for left channel inputs and for bias current generator; typically $V_{DDAL}/2$
INTL-	34	output from the left negative switched-capacitor integrator; input to differential operational-amplifier
FBL-	35	feedback connection for the left negative switched-capacitor integrator
V_{SSAL}	36	0 V supply for left channel
FBL+	37	feedback connection for the left positive switched-capacitor integrator
INTL+	38	output from the left positive switched-capacitor integrator; input to differential operational-amplifier
V_{DDAL}	39	analog 5 V supply for left channel
TEST2	40	test 2; this pin should be left open-circuit
TEST3	41	test 3; this pin should be left open-circuit
DOL	42	digital output left; left channel one-bit code for TDA1547; when disabled this pin will be driven LOW
XSYS2	43	output clock at a frequency of half the master clock frequency
DOR	44	digital output right; right channel one-bit code for TDA1547; when disabled this pin will be driven LOW

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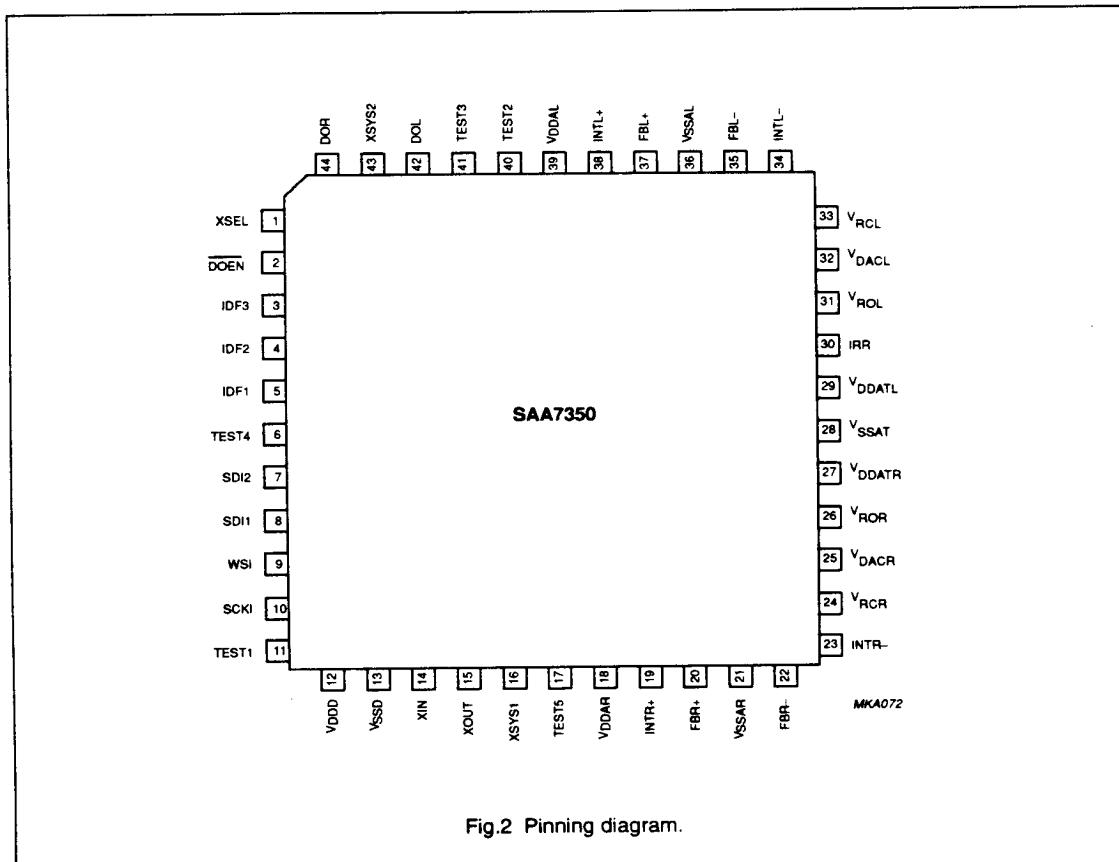
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Fig.2 Pinning diagram.

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FUNCTIONAL DESCRIPTION

General

The SAA7350 bitstream conversion CMOS DAC contains a flexible interface supporting a variety of formats. This enables it to be used with a number of available digital filters with wordlengths of up to 20 bits and upsampling up to 8 f_s. The system sampling frequency (f_s) can be between 16 kHz and 53 kHz.

The analog section contains four one-bit DACs operated in differential mode to achieve high performance signal-to-noise ratio, channel separation and total harmonic distortion.

Input interface

The SAA7350 supports the following modes:

- I²S with dataword rates of f_s, 2 f_s or 4 f_s with wordlengths of up to 20 bits (see Fig. 3). A minimum of 16 bit-clock cycles per word is required.

- Sony serial format for dataword rate of f_s, 2 f_s or 4 f_s with wordlengths of 16, 18 or 20 bits (see Fig. 4). As this format idles on the MSB it is necessary to know how many bits are being transmitted.

- Simultaneous mode for dataword rates of f_s, 2 f_s, 4 f_s or 8 f_s with wordlengths of up to 20 bits idling on the least significant bit (see Fig. 5). A minimum of 16 bit-clock cycles per word is required.

- Simultaneous mode for dataword rates of f_s, 2 f_s, 4 f_s and 8 f_s with wordlengths of 18 or 20 bits idling on the MSB (see Fig. 6). As this format idles on the MSB it is necessary to know how many bits are being transmitted.

- Simultaneous mode for dataword rates of f_s, 2 f_s, 4 f_s or 8 f_s with wordlengths of up to 20 bits using burst clocks (see Fig. 7). A minimum of 16 bit-clock cycles is required. This mode is restricted to having the bit clock at less than or equal to half the master clock frequency supplied to the SAA7350.

The choice of these formats is given by the pins IDF1 to IDF3 as shown below.

Input data formats

IDF3	IDF2	IDF1	format
0	0	0	I²S format up to 20 bits
0	0	1	Sony serial format 16 bits
0	1	0	Sony serial format 18 bits
0	1	1	Sony serial format 20 bits
1	0	0	simultaneous format idling on LSB up to 20 bits
1	0	1	simultaneous format idling on MSB 18 bits
1	1	0	simultaneous format idling on MSB 20 bits
1	1	1	simultaneous format burst clock up to 20 bits

The transfer on the serial input has to be synchronous to the master clock.

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Clock frequency

The device can run at an input clock frequency of either 384 f_s or 256 f_s (pin XSEL) outputting a system clock at the same frequency on XSYS1 and half input clock frequency on XSYS2. f_s can be between 16 kHz and 53 kHz.

Noise shaping

Third order noise shaping is implemented on the SAA7350 to give an improved signal-to-noise ratio. DC offset and out-of-band dither is added to prevent idle patterns in the audio band.

Bitstream conversion DAC

The digital-to-analogue conversion in the SAA7350 is performed using the Philips bitstream conversion technique. The input from the digital filter is oversampled to 8 f_s by means of a digital sample and hold and converted to a 1-bit pulse density modulated (PDM) signal. A switched capacitor technique is used for the bitstream conversion to convert the PDM signal to an analog signal. A fixed charge is either added or subtracted from the virtual earth node of an integrator . As this output is a continuous time output a highly symmetrical operational amplifier is used to give a low distortion figure.

In order to increase the output signal-to-noise ratio and THD performance, internal operational-amplifiers are provided so that the device is operated in differential mode. With this technique, any common mode signals cancel thus improving the signal-to-noise ratio and total harmonic distortion.

TDA1547 Interface

The SAA7350 can also be used to provide oversampling and noise shaping for the TDA1547. One-bit codes and clock outputs are supplied for inputs to the TDA1547.

LIMITING VALUES

In accordance with the Absolute Maximum System (IEC 134)

SYMBOL	PARAMETER	MIN.	MAX.	UNIT
V_{DDA}	analog supply voltage; note 1	–0.5	+6.5	V
V_I	DC input voltage	–0.5	+6.5	V
I_{IK}	DC input diode current	-	±20	mA
V_O	DC output voltage	–0.5	+6.5	V
I_O	DC output source or sink current	-	±20	mA
I_{DD} or I_{SS}	DC V_{DD} or V_{SS} current (total)	-	±0.5	A
T_{stg}	storage temperature range	–65	+150	°C
T_{amb}	operating ambient temperature range	–10	+70	°C
V_{es}	electrostatic handling; note 2	–1000	+1000	V

Notes to the limiting values

1. All V_{DD} and V_{SS} pins must be connected externally to the same power supply unit.
2. Equivalent to discharging a 100 pF capacitor through a 1.5 kΩ series resistor with a rise time of 15 ns.

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CHARACTERISTICS

V_{DD} = 5 V; V_{SS} = 0 V; T_{amb} = 25 °C; f_{XTAL} = 384 f_s; f_s = 44.1 kHz unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Supplies						
V_{DDA}	supply voltage (analog)		4.5	5.0	5.5	V
I_{DDA}	supply current (analog)		-	45	70	mA
V_{DDD}	supply voltage (digital)		4.5	5.0	5.5	V
I_{DDD}	supply current (digital)		-	30	50	mA
Digital part:						
Inputs: SCKI, WSI, SDI1						
V_{IL}	LOW level input voltage	note 1	−0.5	-	+0.8	V
V_{IH}	HIGH level input voltage	note 1	2.0	-	V_{DD} + 0.5	V
I_{LI}	input leakage current	note 2	−10	0	+10	μA
C_i	input capacitance		-	-	10	pF
Inputs: XSEL, SD12, DOEN, IDF1, IDF2, IDF3		note 3				
V_{IL}	LOW level input voltage	note 1	−0.5	-	+0.8	V
V_{IH}	HIGH level input voltage	note 1	2.0	-	V_{DD} + 0.5	V
Z_i	pull-up impedance		-	50	-	kΩ
C_i	input capacitance		-	-	10	pF
Crystal oscillator input: XIN						
V_{IL}	LOW level input voltage	note 1	−0.5	-	+1.5	V
V_{IH}	HIGH level input voltage	note 1	3.5	-	V_{DD} + 0.5	V
I_{LI}	input leakage current	note 2	−10	0	+10	μA
C_i	input capacitance		-	-	10	pF
Outputs: XSYS1						
V_{OL}	LOW level output voltage	note 1	−0.5	-	+0.4	V
V_{OH}	HIGH level output voltage	note 1	2.4	-	V_{DD} + 0.5	V
C_L	load capacitance		-	-	35	pF
Outputs: XSYS2, DOL, DOR						
V_{OL}	LOW level output voltage		-	-	0.5	V
V_{OH}	HIGH level output voltage		V_{DD} - 0.5	-	-	V
C_L	load capacitance		-	-	20	pF
Crystal oscillator: input XIN/output XOUT						
f_{XTAL}	operating frequency XTAL	note 4	4.096	256 f_s or 384 f_s	20.35	MHz
G_m	mutual conductance	100 kHz	1.5	-	-	mA/V
G_v	small signal voltage gain	$G_v = G_m \times R_o$	3.5	-	-	V/V
C_i	input capacitance		-	-	10	pF

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SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Crystal oscillator: input XIN/output XOUT						
C_{FB}	feedback capacitance		-	-	5	pF
C_O	output capacitance		-	-	10	pF
I_{LI}	input leakage current	note 2	-10	-	+10	µA
Timing						
External clock input: XIN						
f_c	input frequency		4.096	256 f_s or 384 f_s	20.35	MHz
t_r	input rise time	note 5	-	-	10	ns
t_f	input fall time	note 5	-	-	10	ns
t_{HIGH}	input HIGH time (relative to clock period)	at 1.5 V	30	-	70	%
System clock output: XSYS1	note 6					
t_r	output rise time	note 5	-	-	10	ns
t_f	output fall time	note 5	-	-	10	ns
t_{HIGH}	output HIGH time (relative to clock period)	note 7	-	50	-	%
Data outputs: DOL, DOR	see Fig.8; note 8					
t_r	data output rise time		-	10	15	ns
t_f	data output fall time		-	10	15	ns
t_{SU}	data output set-up time		0	-	-	ns
t_{HD}	data output hold time		25	-	-	ns
Data clock output: XSYS2	see Fig. 8; note 8					
t_r	clock output rise time		-	5	10	ns
t_f	clock output fall time		-	5	10	ns
t_{HIGH}	clock output HIGH time	note 9	40	-	-	ns
t_{LOW}	clock output LOW time	note 9	40	-	-	ns
Input timing	see Fig.9					
Clock input: SCKI						
f_{cl}	input clock frequency		0.256	-	20.35	MHz
msr	mark space ratio		40:60	-	60:40	
Word select input: WSI						
f_i	input frequency		14.4	-	424	kHz
Data inputs: SDI1, SDI2/word select input: WSI						
$t_{SU\ DAT}$	input set-up time		-	20	-	ns
$t_{HD\ DAT}$	input hold time (relative to SCKI)		0	-	-	ns

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SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Analog part						
Reference voltage source: VRC						
V_{ref}	high-impedance reference voltage level		-	2.5	-	V
Outputs: INTL+, INTL-, INTR+, INTR-		notes 10 and 11				
$V_{AO(RMS)}$	output level at 0 dB (RMS value)	note 12	-	0.9	-	V
$V_{DIFF(RMS)}$	application output level at 0 dB (RMS value)	note 13	1.62	1.80	1.98	V
DAC performance		note 12				
DR	dynamic range		93	98	-	dB
THD + N	total harmonic distortion	at 0 dB/1 kHz	-	−96	−93	dB
	digital silence		-	−103	−100	dB
a	channel separation	1 kHz	-	100	-	dB
RR	power supply rejection ratio to V_{DD}		-	60	-	dB
	channel matching	note 14	-	-	±0.25	dB
le	linearity	0 to −100 dB	-	±1	-	dB

Notes to the characteristics

1. Minimum V_{IL}, V_{OL} and maximum V_{IH}, V_{OH} are peak values to allow for transients.

2. I_{LIMIN} and I_{LOMIN} measured at $V_I = 0$ V; I_{LIMAX} and I_{LOMAX} measured at $V_I = V_{DD}$.

3. Pins XSEL and SDI2 are internally pulled high when not connected. XSEL HIGH indicates a crystal frequency of 384 f_s.

4. f_{XTAL} is a multiple of the system sampling frequency f_s. f_s can be between 16 and 53 kHz.

5. Reference levels = 0.8 V and 2.0 V.

6. Output times are measured with a capacitve load of 35 pF. XSYS2 is half the master clock frequency. See Fig.10 for relative clock timings.

7. t_{HIGH} valid only when used with XTAL, with 50% input mark space ratio. XSYS1 t_{HIGH} is measured at $V_{DD}/2$.

8. Output times are measured with a capacitive load of 20 pF. XSYS2 is half the master clock frequency. Data output hold time is relative to XSYS2.

9. XSYS2 output HIGH/LOW times are for 20.35 MHz. Minimum value for 16.934 MHz is 49 ns.

10. Device measured in differential mode with external components shown in recommended application diagram (see Figs 13 and 14). It should be noted that for 1.80 mV output, feedback resistors R16a, R17a, R16b, R17b should be 31.6 kΩ. Application diagram shows preferred type range values of 30 kΩ which give 1.80 x 30/31.6 = 1.70 mV.

11. Maximum load (excluding feedback) is 10 kΩ, 100 pF to VRO (V_{ref}). Dynamic output impedance is typically 150 Ω.

12. Output level tracks linearly with sampling frequency (f_s). DAC performance quoted for 18-bit, 4 f_s input.

13. Application output level measured at output from first operational-amplifier stage in Figs 13 and 14.

14. With matched external components.

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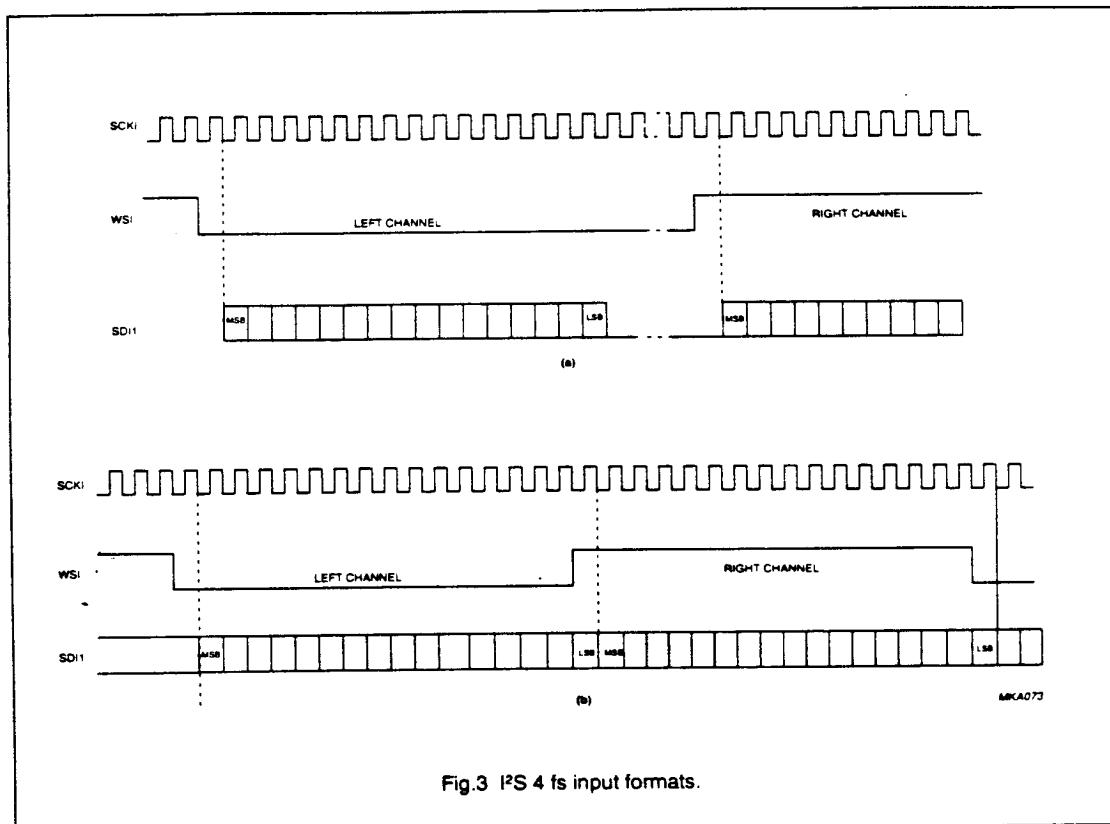
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Fig.3 I²S 4 fs input formats.
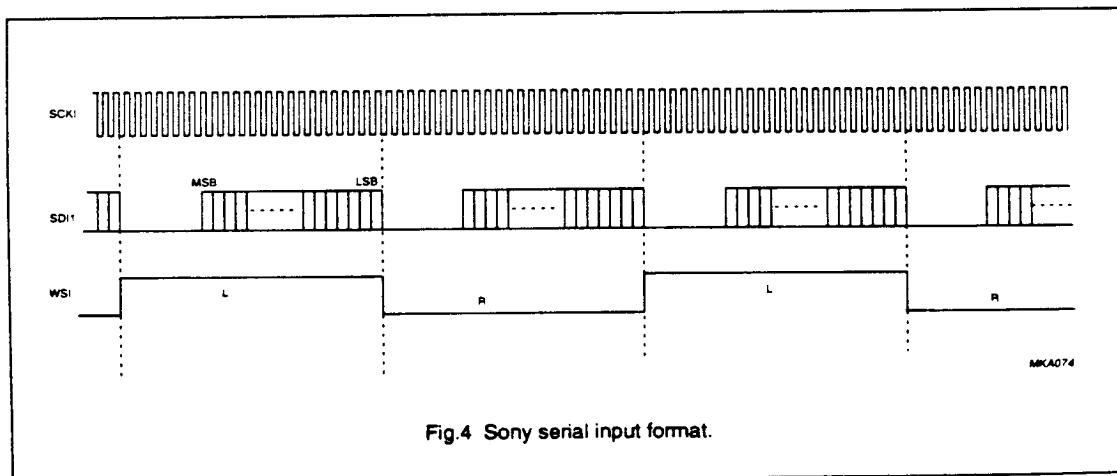
Fig.4 Sony serial input format.

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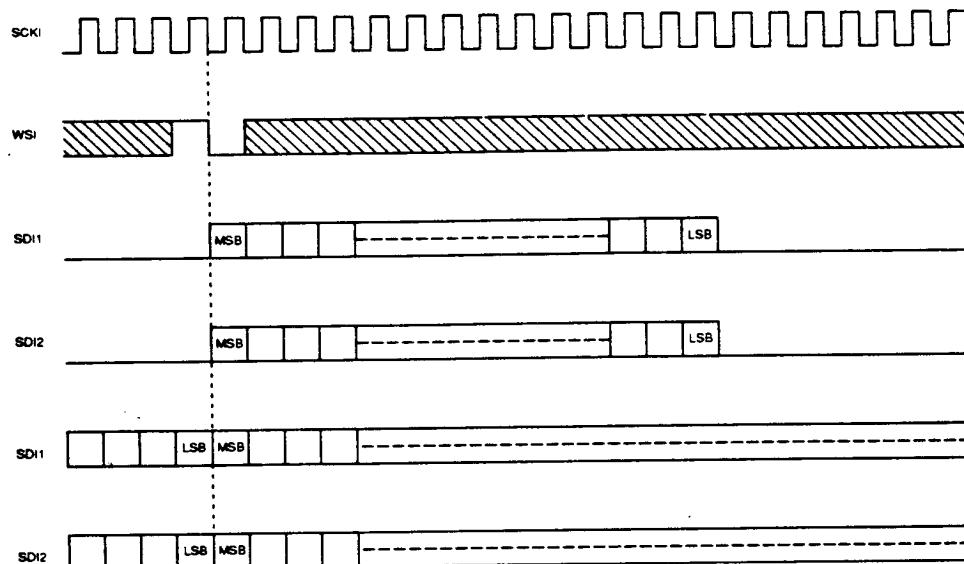
Fig.5 Simultaneous mode input format - continuous clock idling on LSB.

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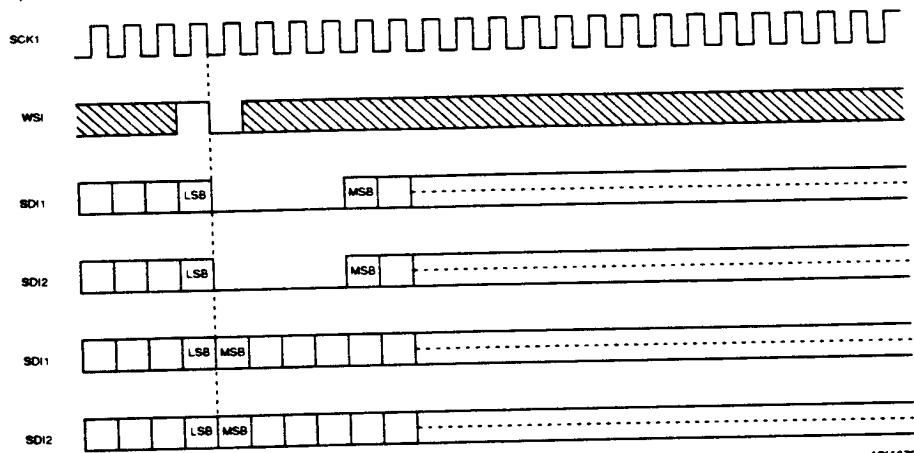
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Fig.6 Simultaneous mode input format - continuous clock idling on MSB.

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Fig.7 Simultaneous burst clock input format.
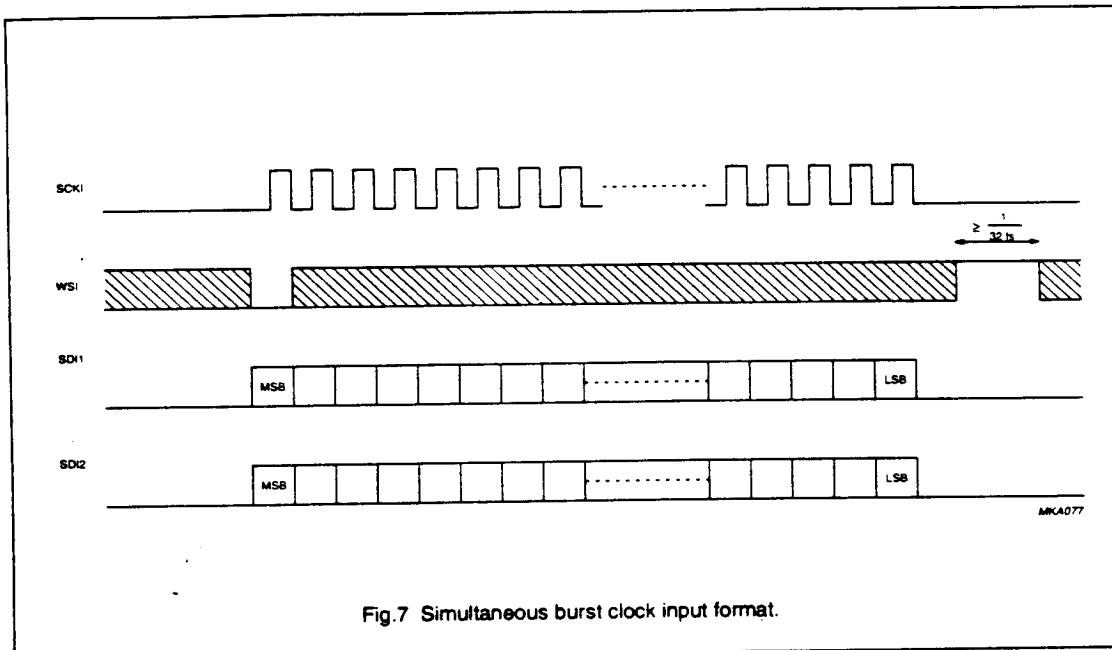
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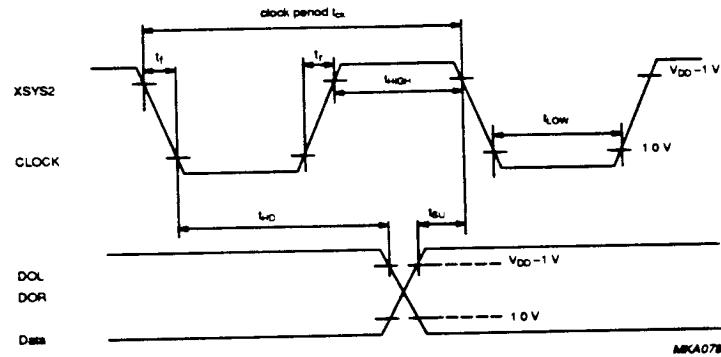
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Fig.8 One bit code timing.
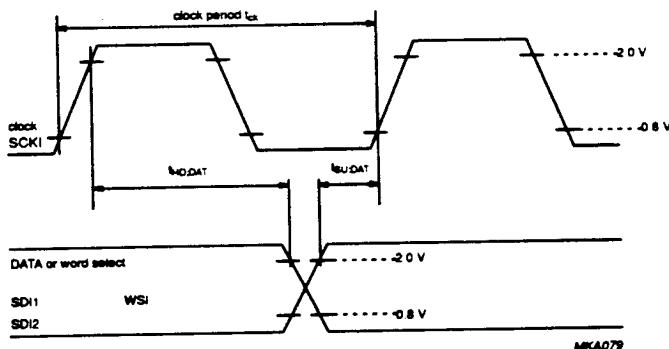
Fig.9 Input timing (valid for all input modes).

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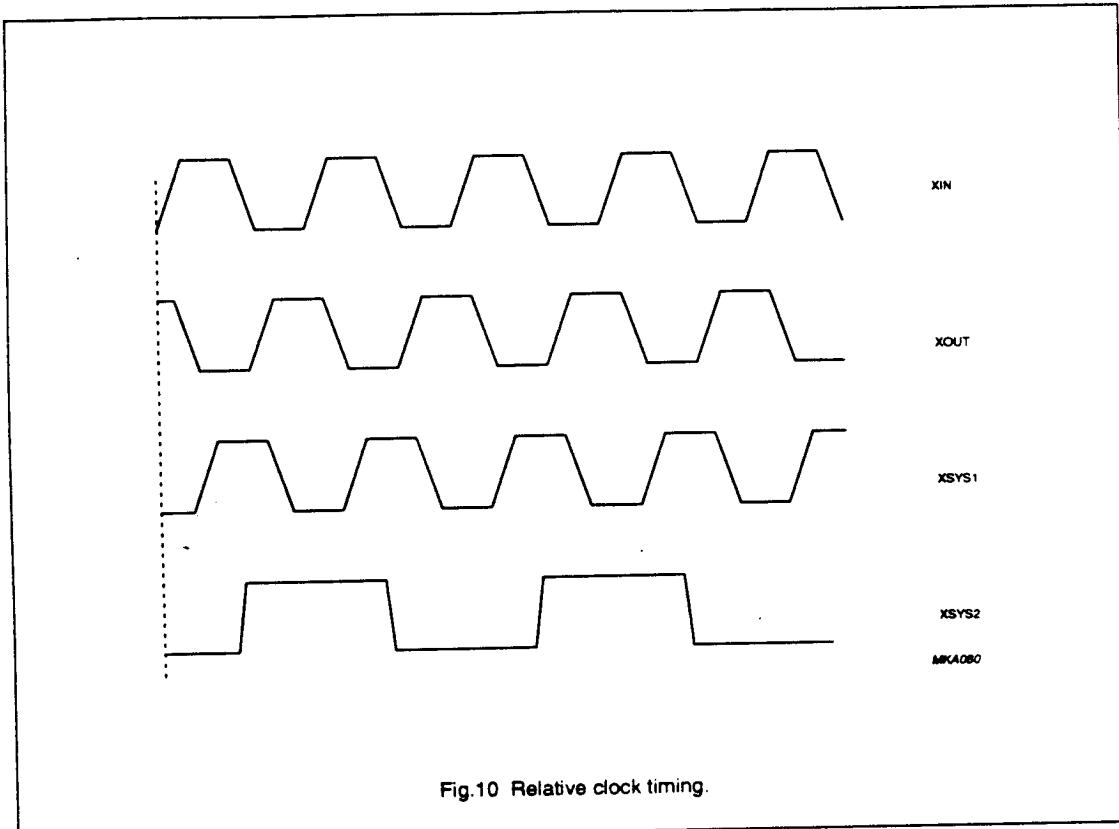
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XIN

XOUT

XSYS1

XSYS2

MKA080

Fig.10 Relative clock timing.
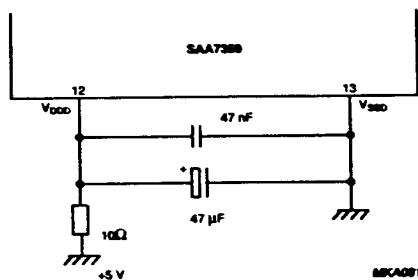
Fig.11 Digital voltage supply.
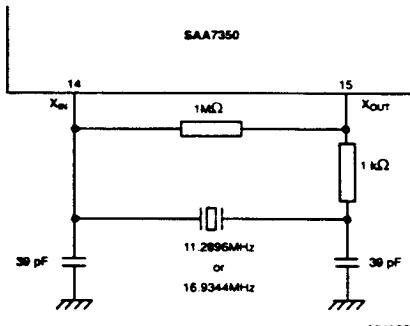
Fig.12 Crystal oscillator.

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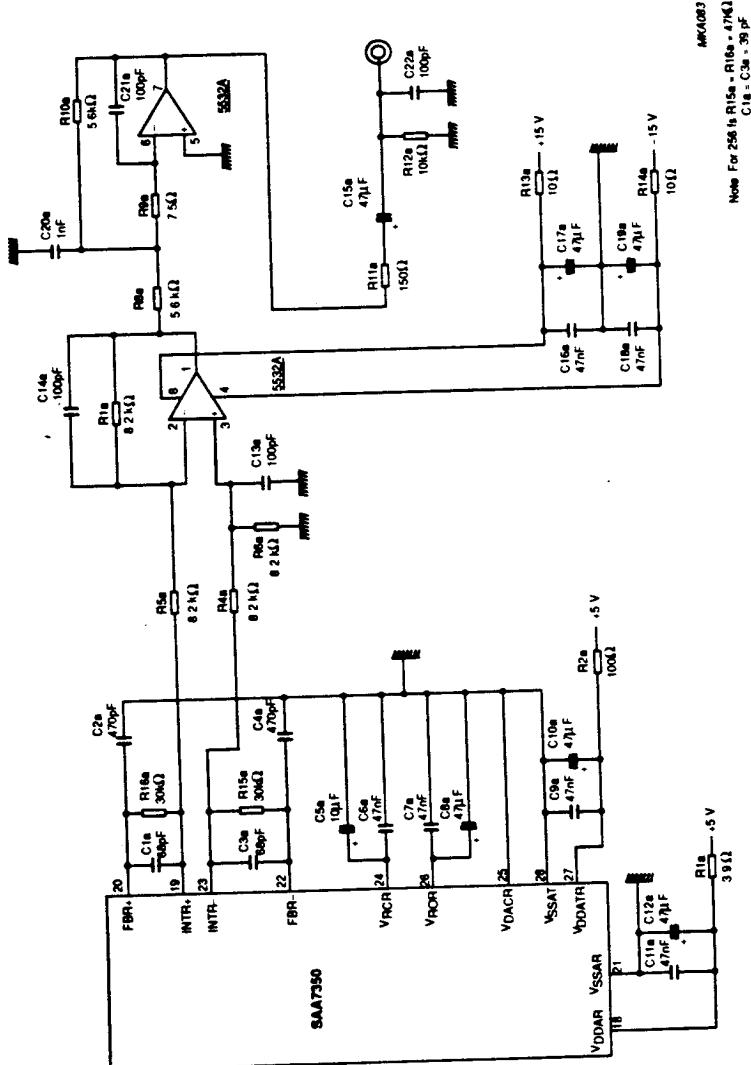
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Fig. 13 SAA7350 application circuit - analog section right channel (384 fs, 44.1 kHz).
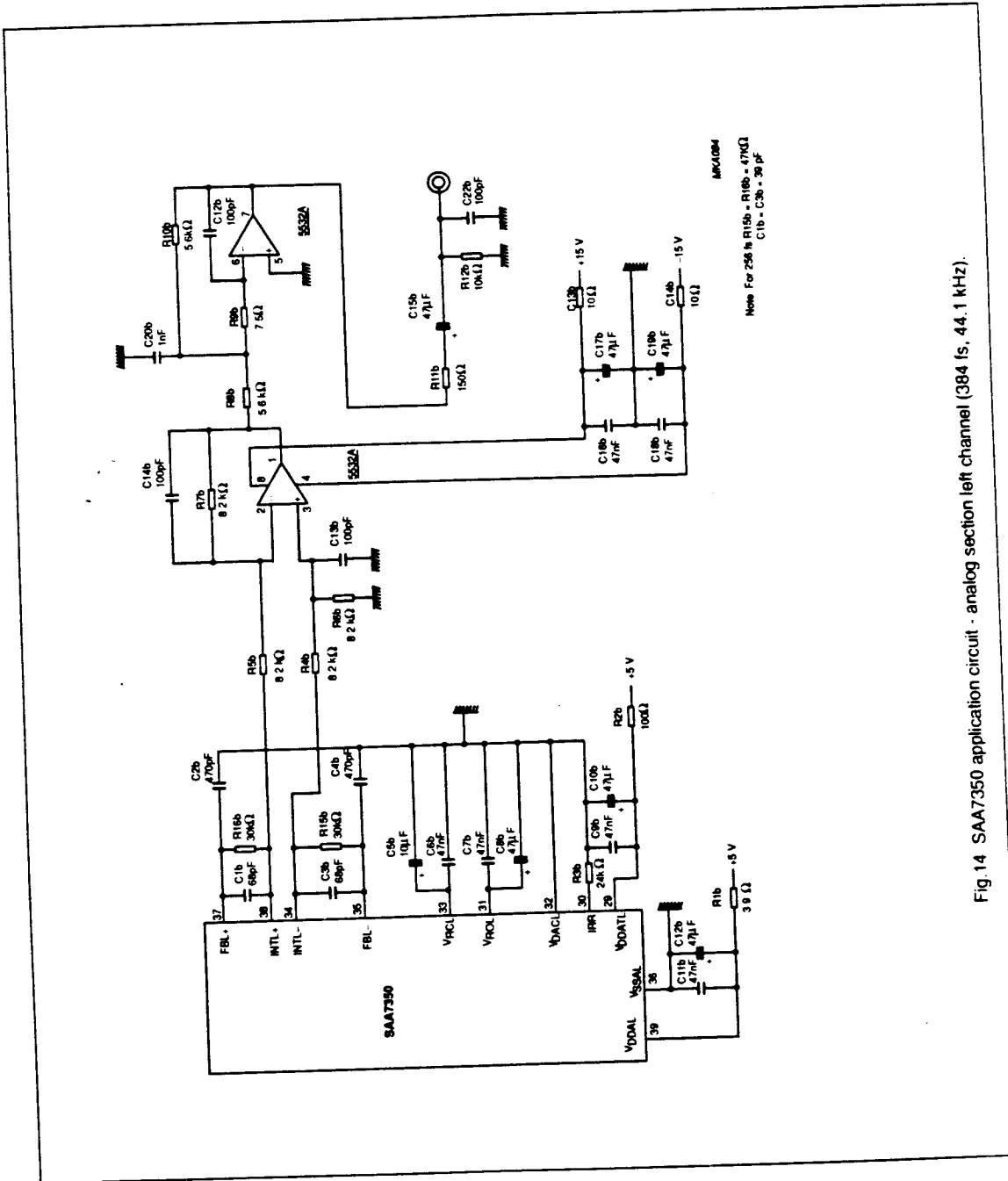
Fig.14 SAA7350 application circuit - analog section left channel (384 fs, 44.1 kHz).